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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/638,172	08/11/2000	Doug A. Hawks	00CON115P	8010	
7:	590 02/01/2002				
Farjami & Farjami LLP 16148 Sand Canyon			EXAMINER		
Irvine, CA 92			NGO, HI	NGO, HUNG V	
			ART UNIT	PAPER NUMBER	
			2831		
			DATE MAILED: 02/01/2002		

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No. 09/638,172

Applicant(s)

Hawks et al

Examiner

Hung V. Ngo

Art Unit 2831

The MAILING DATE of this communication appears	on the cover sheet with the correspondence address	
Period for Reply		
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET THE MAILING DATE OF THIS COMMUNICATION.	TO EXPIRE 3 MONTH(S) FROM	
 Extensions of time may be available under the provisions of 37 CF after SIX (6) MONTHS from the mailing date of this communication. If the period for reply specified above is less than thirty (30) days, 	ation.	
be considered timely.	period will apply and will expire SIX (6) MONTHS from the mailing date of this	
- Failure to reply within the set or extended period for reply will, by	statute, cause the application to become ABANDONED (35 U.S.C. § 133). mailing date of this communication, even if timely filed, may reduce any	
Status		
1) Responsive to communication(s) filed on Nov 13, 2		
2a) ☐ This action is FINAL. 2b) ☐ This action is FINAL.	ion is non-final.	
3) Since this application is in condition for allowance e closed in accordance with the practice under Ex pair	except for formal matters, prosecution as to the merits is rte Quayle, 1935 C.D. 11; 453 O.G. 213.	
Disposition of Claims		
	is/are pending in the application.	
	is/are withdrawn from consideration.	
5) Claim(s)	is/are allowed.	
6) 🔀 Claim(s) 11, 14-16, 18, and 19	is/are rejected.	
7) Claim(s)	is/are objected to.	
8) Claims	are subject to restriction and/or election requirement.	
Application Papers		
9) The specification is objected to by the Examiner.		
10) The drawing(s) filed on is/are	objected to by the Examiner.	
11) The proposed drawing correction filed on	is: a) \square approved b) \square disapproved.	
12) \square The oath or declaration is objected to by the Exami	iner.	
Priority under 35 U.S.C. § 119		
13) Acknowledgement is made of a claim for foreign process.	riority under 35 U.S.C. § 119(a)-(d).	
a) \square All b) \square Some* c) \square None of:		
1. Certified copies of the priority documents hav		
	e been received in Application No	
application from the International Bure		
*See the attached detailed Office action for a list of the 14) Acknowledgement is made of a claim for domestic		
Acknowledgement is made of a claim for domestic	priority dilating of order a stronger	
Attachment(s)		
15) Notice of References Cited (PTO-892)	18) Interview Summary (PTO-413) Paper No(s).	
16) Notice of Draftsperson's Patent Drawing Review (PTO-948)	19) Notice of Informal Patent Application (PTO-152) 20) Other:	
17) Information Disclosure Statement(s) (PTO-1449) Paper No(s).	20/ Olim.	

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless --

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 11, 14-16, 18 are rejected under 35 U.S.C. 102(b) as being anticipated by Wilson et al.

Wilson et al disclose a printed circuit board (12) including a die (22) attached to said printed circuit board; said printed circuit comprising a first layer of metal (21) and a second layer of metal (14) on bottom and top surfaces of the board; a through hole (32) in said printed circuit board, said hole being adjacent to said die, said hole being filled with a mold compound (28), said mold compound surrounding and covering said die, wherein said mold compound is locked into first and second layers of said printed circuit board (re claim 11).

Re claim 14, a bond wire (26), wherein a first end of said bond wire is bonded to a die bonding pad on said die and a second end of said bond wire is bonded to a printed circuit board bonding location on said printed circuit board.

Re claim 15, wherein said mold compound is selected from the group consisting of multi functional epoxy, novolac, and biphenyl resin (col 4, lines 44-46).

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Re claim 16, a layer of die attach (24) between said die and said printed circuit board (Fig

1).

Re claim 18 the layer of die attach (24) between said die and said second layer of metal

(Fig 1).

Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness

rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in

section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are

such that the subject matter as a whole would have been obvious at the time the invention was made to a person

having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the

manner in which the invention was made.

Claim 19 is rejected under 35 U.S.C. 103(a) as being unpatentable over Wilson et al in

view of Garbelli et al

The teaching of Wilson et al as discussed above does not disclose the second layer of

metal comprises gold plated copper.

Garbelli et al disclose a second layer of metal (140) below the die comprising gold plated

copper to allow a better compatibility with the layer of die attach and facilitating the heat transfer

from the back of the device (col 4, lines 42-48)(Fig 1). It would have been obvious to one

having ordinary skill in the art at the time the invention was made to use the gold plated copper

for the second layer of metal of Wilson et al for the purpose of allowing a better compatibility

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with the layer of die attach and facilitating the heat transfer from the back of the die as taught by Garbelli et al.

Response to Arguments

Applicant's arguments with respect to claims 11, 14-16, 18, 19 have been considered but are most in view of the new ground(s) of rejection.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

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Communication

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hung V. Ngo whose telephone number is (703) 308-7614. The examiner can normally be reached on Tuesday to Friday from 8:30 am to 06:00 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Dean Reichard, can be reached on (703) 308-3682.

The fax phone number for this Group is (703) 305-3431 or (703) 305-3432.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0956.

Hung V. Ngo

January 28, 2002

DEAN A. REICHARD

SUPERVISORY PATENT EXAMINER

TECHNOLOGY CENTER 2800